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PTO/SB/81A (12-08)

Approved for use through 11/30/2011. OMB 0651-0035

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PATENT - POWER OF ATTORNEY
OR
REVOCATION OF POWER OF ATTORNEY
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AND

CHANGE OF CORRESPONDENCE ADDRESS

		_	
Patent Number	7,431,705		
Issue Date	10/07/2008		
First Named Inventor	Wendy Lee Wilkins		
Title	Die-First Multi-Chip Modules and Methods of Manufacture		
Attorney Docket Number			

I hereby revoke all previous powers of attorney given in the above-identified patent.						
A Powe	X A Power of Attorney is submitted herewith.					
OR I hereby appoint Practitioner(s) associated with the following Customer Number as my/our attorney(s) or agent(s) with respect to the patent identified above, and to transact all business in the United States Patent and Trademark Office connected therewith:						
I hereby appoint Practitioner(s) named below as my/our attorney(s) or agent(s) with respect to the patent identified above, and to transact all business in the United States Patent and Trademark Office connected therewith:						
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Please recognize or change the correspondence address for the above-identified patent to: The address associated with the above-mentioned Customer Number. OR The address associated with Customer Number: OR Firm or Individual Name Union Semiconductor Technology Corporation Address 70 Little West Street, Unit 8F City New York State NY Zip 10004						
Country Telephone	USA 917-412-1378	USA 917-412-1378 Email ritaho_tw@yahoo.com		o.com		
I am the: Inventor, having ownership of the patent. OR Patent owner. Statement under 37 CFR 3.73(b) (Form PTO/SB/96) submitted herewith or filed on						
SIGNATURE of Inventor or Patent Owner						
Signature	Signature			11/19/10		
Name Hong-Lien Lin Telephone 917-412-1378						
Title and Company Chairman, Union Semiconductor Technology Corporation NOTE: Signatures of all the inventors or patent owners of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.						
*Total of forms are submitted.						

This collection of information is required by 37 CFR 1.31, 1.32 and 1.33. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 3 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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The Privacy Act of 1974 (P.L. 93-579) requires that you be given certain information in connection with your submission of the attached form related to a patent application or patent. Accordingly, pursuant to the requirements of the Act, please be advised that: (1) the general authority for the collection of this information is 35 U.S.C. 2(b)(2); (2) furnishing of the information solicited is voluntary; and (3) the principal purpose for which the information is used by the U.S. Patent and Trademark Office is to process and/or examine your submission related to a patent application or patent. If you do not furnish the requested information, the U.S. Patent and Trademark Office may not be able to process and/or examine your submission, which may result in termination of proceedings or abandonment of the application or expiration of the patent.

The information provided by you in this form will be subject to the following routine uses:

 The information on this form will be treated confidentially to the extent allowed under the Freedom of Information Act (5 U.S.C. 552) and the Privacy Act (5 U.S.C 552a). Records from this system of records may be disclosed to the Department of Justice to determine whether disclosure of these records is required by the Freedom of Information Act.

A record from this system of records may be disclosed, as a routine use, in the course of presenting evidence to a court, magistrate, or administrative tribunal, including disclosures to

opposing counsel in the course of settlement negotiations.

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4. A record in this system of records may be disclosed, as a routine use, to a contractor of the Agency having need for the information in order to perform a contract. Recipients of information shall be required to comply with the requirements of the Privacy Act of 1974, as

amended, pursuant to 5 U.S.C. 552a(m).

5. A record related to an International Application filed under the Patent Cooperation Treaty in this system of records may be disclosed, as a routine use, to the International Bureau of the World Intellectual Property Organization, pursuant to the Patent Cooperation Treaty.

. A record in this system of records may be disclosed, as a routine use, to another federal agency for purposes of National Security review (35 U.S.C. 181) and for review pursuant to

the Atomic Energy Act (42 U.S.C. 218(c)).

7. A record from this system of records may be disclosed, as a routine use, to the Administrator, General Services, or his/her designee, during an inspection of records conducted by GSA as part of that agency's responsibility to recommend improvements in records management practices and programs, under authority of 44 U.S.C. 2904 and 2906. Such disclosure shall be made in accordance with the GSA regulations governing inspection of records for this purpose, and any other relevant (i.e., GSA or Commerce) directive. Such disclosure shall not be used to make determinations about individuals.

8. A record from this system of records may be disclosed, as a routine use, to the public after either publication of the application pursuant to 35 U.S.C. 122(b) or issuance of a patent pursuant to 35 U.S.C. 151. Further, a record may be disclosed, subject to the limitations of 37 CFR 1.14, as a routine use, to the public if the record was filed in an application which became abandoned or in which the proceedings were terminated and which application is referenced by either a published application, an application open to public inspection or an

issued patent.

 A record from this system of records may be disclosed, as a routine use, to a Federal, State, or local law enforcement agency, if the USPTO becomes aware of a violation or potential violation of law or regulation.

PTO/SB/96 (07-09) Approved for use through 07/31/2012. OMB 0651-0031

6 211 Under the Paperwork Reduction Act of 1995, no persons a	U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERC re required to respond to a collection of information unless it displays a valid OMB control number
STATEMEN	T UNDER 37 CFR 3.73(b)
Application Owner: Wendy Lee Wilkins	•
Application No./Patent No.: 10/724,981 / 7,431,705	Filed/Issue Date: 11/30/2003 / 10/07/2008
Titled:	
Union Semiconductor Technology Corporation , a	Corporation
(Name of Assignee)	(Type of Assignee, e.g., corporation, partnership, university, government agency, etc.
states that it is:	·
1. The assignee of the entire right, title, and interest	in;
2. an assignee of less than the entire right, title, and	t interest in
(The extent (by percentage) of its ownership inte	rest is%); or
3. the assignee of an undivided interest in the entire	ety of (a complete assignment from one of the joint inventors was made)
the patent application/patent identified above, by virtue of ei	her:
A. An assignment from the inventor(s) of the patent	application/patent identified above. The assignment was recorded in
the United States Patent and Trademark Office a copy therefore is attached.	t Reel 015662 , Frame 0281 , or for which a
OR	
	application/patent identified above, to the current assignee as follows:
	ited States Patent and Trademark Office at
Reel, Fran	e, or for which a copy thereof is attached.
2. From:	To:
	ited States Patent and Trademark Office at
Reel, Fram	e, or for which a copy thereof is attached.
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The document was recorded in the Ur	ited States Patent and Trademark Office at
Reel, Fram	e, or for which a copy thereof is attached.
Additional documents in the chain of title are lis	ed on a supplemental sheet(s).
As required by 37 CFR 3.73(b)(1)(i), the documenta	y evidence of the chain of title from the original owner to the assignee was
or concurrently is being, submitted for recordation pu	
	inal assignment document(s)) must be submitted to Assignment Division in ment in the records of the USPTO. <u>See</u> MPEP 302.08]
The undersigned (whose title is supplied below) is authorize	d to act on behalf of the assignee.
77-776	1./19/10
Signature	Date ·
Hong-Lien Lin	Chairman ————————————————————————————————————
Printed or Typed Name	Title

.This collection of information is required by 37 CFR 3.73(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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the Atomic Energy Act (42 U.S.C. 218(c)).

- 7. A record from this systèm of records may be disclosed, as a routine use, to the Administrator, General Services, or his/her designee, during an inspection of records conducted by GSA as part of that agency's responsibility to recommend improvements in records management practices and programs, under authority of 44 U.S.C. 2904 and 2906. Such disclosure shall be made in accordance with the GSA regulations governing inspection of records for this purpose, and any other relevant (i.e., GSA or Commerce) directive. Such disclosure shall not be used to make determinations about individuals.
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Assignments on the Web > Patent Query

Patent Assignment Abstract of Title

NOTE: Results display only for issued patents and published applications. For pending or abandoned applications please consult USPTO staff.

Total Assignments: 3

Patent #: 7431705

Issue Dt: 10/07/2008

Application #: 10724981

Filing Dt: 11/30/2003

Publication #: 20050115065

Pub Dt: 06/02/2005

Inventor: Wendy Lee Wilkins

Title: DIE-FIRST MULTI-CHIP MODULES AND METHODS OF MANUFACTURE

Assignment: 1

Reel/Frame: 015662/0281

Recorded: 08/09/2004

Pages: 2

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS

Assignor: WILKINS, WENDY LEE

Assignee: UNION SEMICONDUCTOR TECHNOLOGY CORPORATION

15301 HWY 55 W

PLYMOUTH, MINNESOTA 55497

Correspondent: JONES DAY

PAUL E. FRANZ

901 LAKESIDE AVENUE

NORTH POINT

CLEVELAND, OH 44114

Assignment: 2

Reel/Frame: 017136/0929

Recorded: 12/27/2005

Pages: 10

Conveyance: ATTORNEY'S LIEN

Assignor: UNION SEMICONDUCTOR TECHNOLOGY CORPORATION

Exec Dt: 03/29/2005

Exec Dt: 11/25/2003

Assignee: RIDER BENNETT, LLP

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MINNEAPOLIS, MINNESOTA 55402

Correspondent: HANS SUN, 13312-101

RIDER BENNETT, LLP 33 SOUTH SIXTH STREET

SUITE 4900

MINNEAPOLIS, MN 55402

Assignment: 3

Reel/Frame: 017186/0335

Recorded: 08/09/2005

Pages: 13

Conveyance: ATTORNEY'S LIEN

Assignor: UNION SEMICONDUCTOR TECHNOLOGY CORPORATION

Exec Dt: 03/29/2005

Assignee: RIDER BENNETT, LLP

SUITE 4900, 33 SOUTH SIXTH STREET MINNEAPOLIS, MINNESOTA 55402

Correspondent: HANS SUN, 13312-101

RIDER BENNETT, LLP 33 SOUTH SIXTH STREET

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MINNEAPOLIS, MINNESOTA 55402

Search Results as of: 07/24/2010 01:58 PM

If you have any comments or questions concerning the data displayed, contact PRD / Assignments at 571-272-3350. Web interface last modified: October 18, 2008 v.2.0.2

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WHEREAS, I, Wendy Lee Wilkins, 1741 Royal Court, Eau Claire, Wisconsin, 54703, have invented and own a certain invention entitled DIE-FIRST MULTI-CHIP MODULES AND METHODS OF MANUFACTURE for which an application is about to be made for Letters Patent of the United States, said application having been executed on even date herewith, and which may be identified in the United States Patent and Trademark Office by Serial No. 10/ 724,981 filed November 30, 2003; and

WHEREAS, Union Semiconductor Technology Corporation, a corporation incorporated in the State of Minnesota, having a place of business at 15301 Hwy 55 W, Plymouth, Minnesota 55497, (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to an under any and all Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable considerations to me in hand paid by said Assignee, the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, my entire right, title and interest in and to said invention, said application and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights under the International Convention, and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to the abovementioned assignee in accordance herewith.

I further authorize said assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

I hereby authorize the above-mentioned assignee, its successors and assigns or anyone it may. properly designate, to insert in this instrument the filing date and Serial Number of said application when ascertained.

Upon said consideration, I do hereby covenant and agree with the said assignee, its successors and assigns, that I have not and will not execute any writing or do any act whatsoever conflicting with these presents, and that I or my executors or administrators will at any time upon request, without further or additional consideration, but at the expense of said assignee, its successors and assigns, execute such additional writings and do such additional acts as said assignee, its successors and assigns, may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights, occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

In witness whereof, I have hereunto set my hand and affixed my seal.

Date: November 2003

Wendy Lee Wilkins

STATE OF WISCONSIN

On the above date before me personally appeared Wendy Wilkins, to me known to be the person described in and who executed to foregoing instrument and acknowledged that she executed the same as her free act and deed.

Notary Public Exp 11-26-04